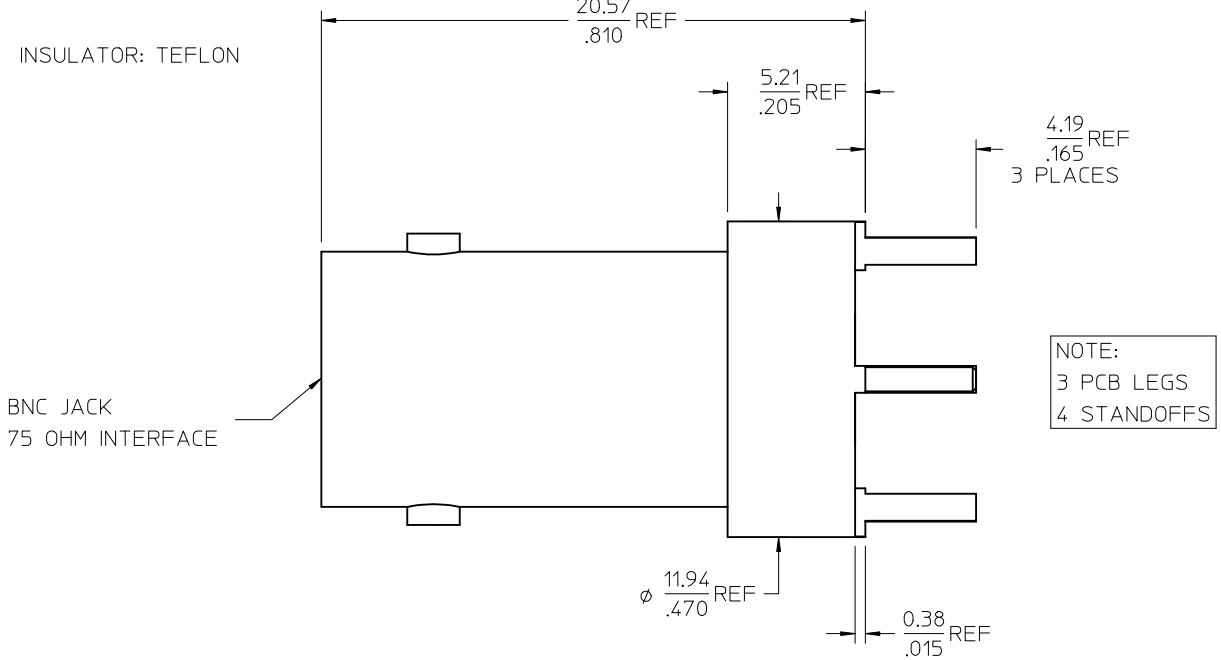
MATERIALS AND FINISHES

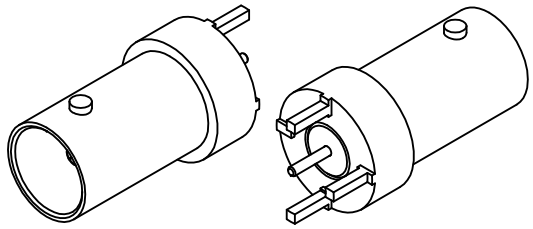
BODY, PRESS RING: BRASS
PLATED NICKEL

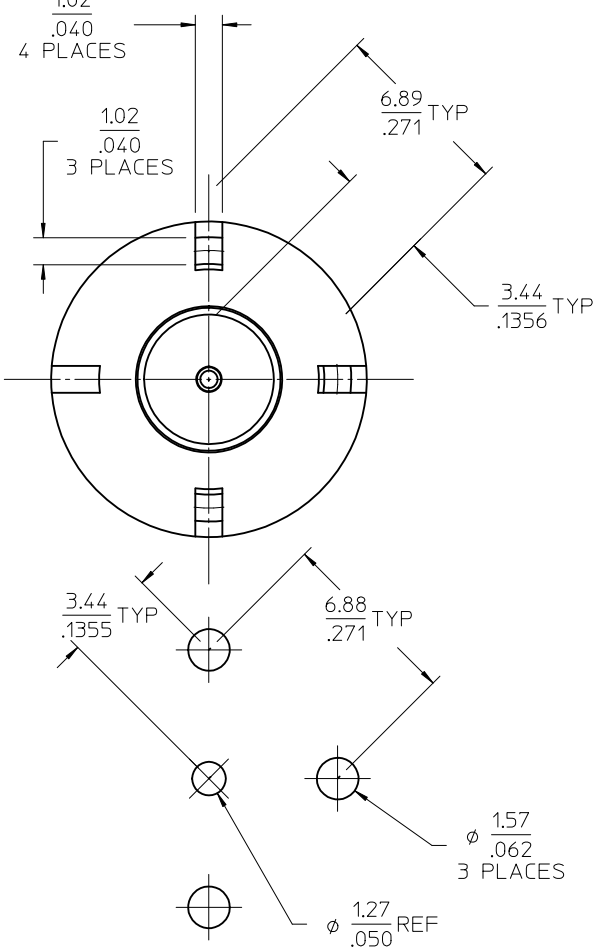
CONTACT: BERYLLIUM COPPER
PLATED GOLD

INSULATOR: TEFLON



NOTE:
3 PCB LEGS
4 STANDOFFS





SUGGESTED PCB LAYOUT

PART NO.	PACKAGING
73171-3541	ONE PER BAG
73171-3540	TRAY

SPECIFICATION	DESCRIPTION
PS-89675-2020	PRODUCT SPECIFICATION

CHG: ADD PS AND -3541
EC NO: URF2011-0572 2011/03/30
DRWN: JWIENER 2011/03/30
CHKD: SSS 2011/04/01
APPR: JWIENER
DESCRIPTION
REV

A1

QUALITY SYMBOLS
▼=0
▽C=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---

ANGULAR ± 2 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN
SCALE
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY: JDW DATE: 2008/07/16
CHECKED BY: SSS DATE: 2008/07/16
APPROVED BY: JDW DATE: 2008/07/16

TITLE: BNC JACK PCB 3GHZ 75 OHM VERTICAL
BNC-J/PCB, EWR-3694

MOLEX INCORPORATED

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-73171-354
SHEET NO.: 1 OF 1

SIZE C

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